



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Akram et al.

Serial No.: 10/033,234

Filed: December 28, 2001

For: MULTI-CHIP MODULE SYSTEM
AND METHOD OF FABRICATION

Confirmation No.: 9689

Examiner: D. Graybill

Group Art Unit: 2827

Attorney Docket No.: 2754.5US
(95-0742.05/US)

Notice of Allowance Mailed:

July 16, 2003

NOTICE OF EXPRESS MAILING

Express Mail Mailing Label Number: EV 326918685 US

Date of Deposit with USPS: October 14, 2003

Person making Deposit: Christopher Haughton

AMENDMENT PURSUANT TO 37 C.F.R. § 1.312(a)

Mail Stop ISSUE FEE
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Please amend the above-referenced application as follows:

Amendments to the Specification appear on page 2 of this paper.

Amendments to the Claims are reflected in the listing of claims which begins on page 3
of this paper.

Remarks begin on page 15 of this paper.